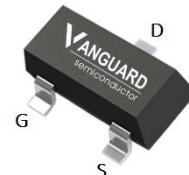


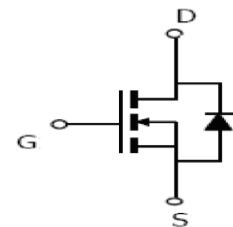
## Features

- N-Channel, 2.5V Logic Level Control
- Enhancement mode
- Low on-resistance  $R_{DS(on)}$  @  $V_{GS}=2.5$  V
- Fast Switching and High efficiency
- Pb-free lead plating; RoHS compliant

$V_{DS}$	20	V
$R_{DS(on),TYP}$ @ $V_{GS}=10$ V	11	$m\Omega$
$R_{DS(on),TYP}$ @ $V_{GS}=4.5$ V	12	$m\Omega$
$R_{DS(on),TYP}$ @ $V_{GS}=2.5$ V	14	$m\Omega$
$I_D$	8	A

**SOT23-3L**


Part ID	Package Type	Marking	Tape and reel information
VS2622AL	SOT23-3L	VS15	3000pcs/reel



## Maximum ratings, at $T_A=25$ °C, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	20	V
$V_{GS}$	Gate-Source voltage	$\pm 12$	V
$I_S$	Diode continuous forward current	$T_A = 25^\circ C$	A
$I_D$	Continuous drain current @ $V_{GS}=4.5V$	$T_A = 25^\circ C$	A
		$T_A = 100^\circ C$	A
$I_{DM}$	Pulse drain current tested ①	$T_A = 25^\circ C$	A
$P_D$	Maximum power dissipation	$T_A = 25^\circ C$	W
$T_{STG}, T_J$	Storage and junction temperature range	-55 to 150	°C

## Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JL}$	Thermal Resistance, Junction-to-Lead	60	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	100	°C/W

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	20	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_j=25^\circ\text{C}$ )	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_j=125^\circ\text{C}$ )	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS}(\text{TH})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	0.4	0.7	1	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=5\text{A}$	--	11	15	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=5\text{A}$	--	12	16	$\text{m}\Omega$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=3\text{A}$	--	14	19	$\text{m}\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=10\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	950	1210	1450	pF
$C_{\text{oss}}$	Output Capacitance		130	195	260	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		110	170	230	pF
$R_g$	Gate Resistance	f=1MHz	--	3.7	--	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=5\text{A}, V_{\text{GS}}=4.5\text{V}$	--	18	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	7.5	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	8.5	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=10\text{V}, I_{\text{D}}=5\text{A}, R_{\text{G}}=3\Omega, V_{\text{GS}}=4.5\text{V}$	--	3.1	--	$\mu\text{s}$
$t_r$	Turn-on Rise Time		--	4.6	--	$\mu\text{s}$
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	9	--	$\mu\text{s}$
$t_f$	Turn-Off Fall Time		--	9.4	--	$\mu\text{s}$
<b>Source- Drain Diode Characteristics@ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=5\text{A}, V_{\text{GS}}=0\text{V}$	--	0.8	1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{sd}}=5\text{A}, \frac{di}{dt}=500\text{A}/\mu\text{s}$	--	13	--	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		--	17	--	nC

**NOTE:**

① Repetitive rating; pulse width limited by max. junction temperature.

② Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .



Vanguard  
Semiconductor

VS2622AL

20V/8A N-Channel Advanced Power MOSFET

## Typical Characteristics

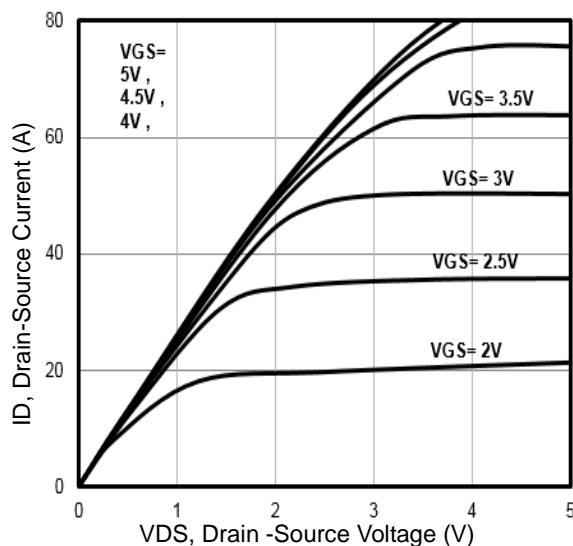


Fig1. Typical Output Characteristics

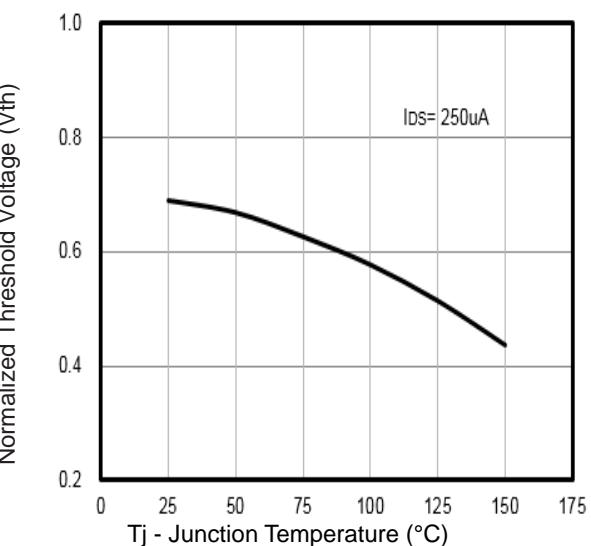


Fig2.  $V_{GS(TH)}$  Gate -Source Voltage Vs. $T_j$

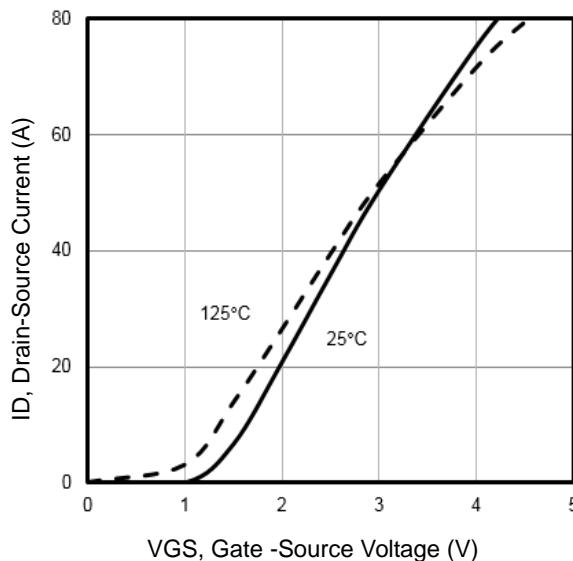


Fig3. Typical Transfer Characteristics

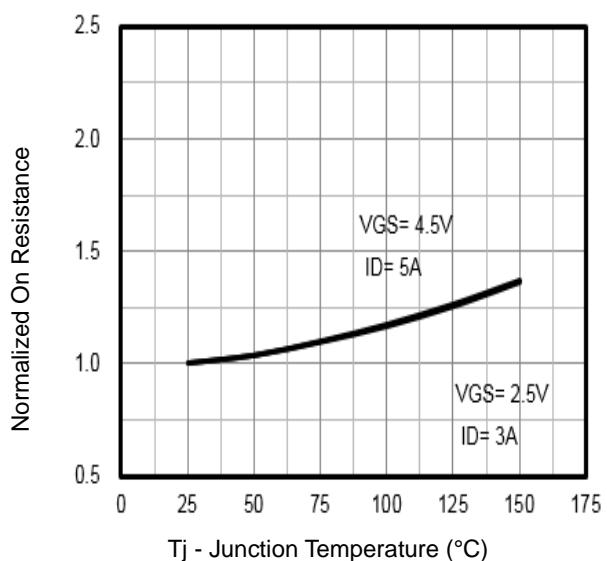


Fig4. Normalized On-Resistance Vs.  $T_j$

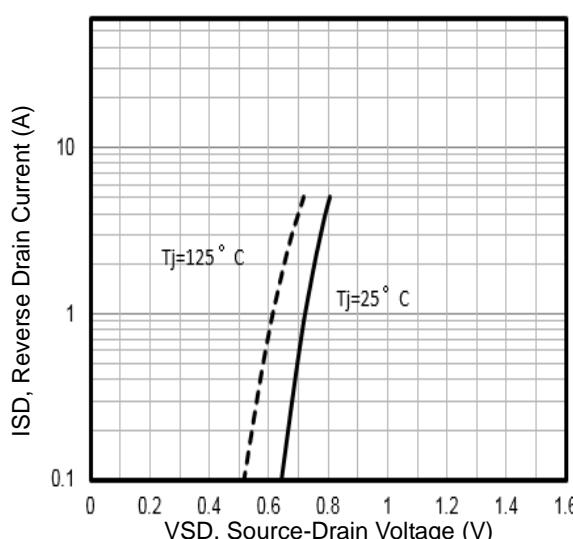


Fig5. Typical Source-Drain Diode Forward Voltage

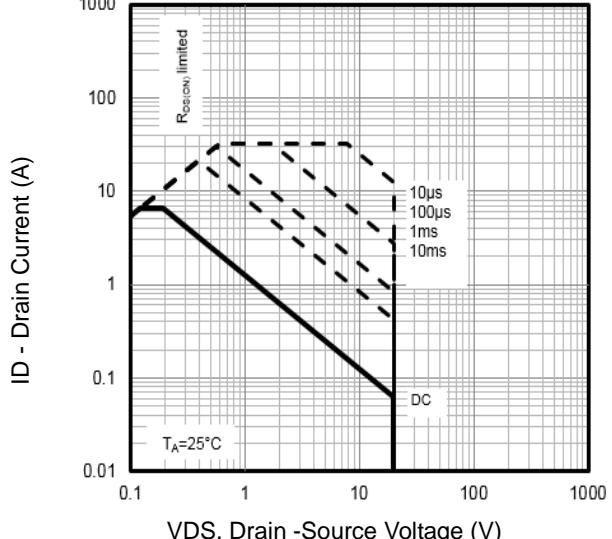
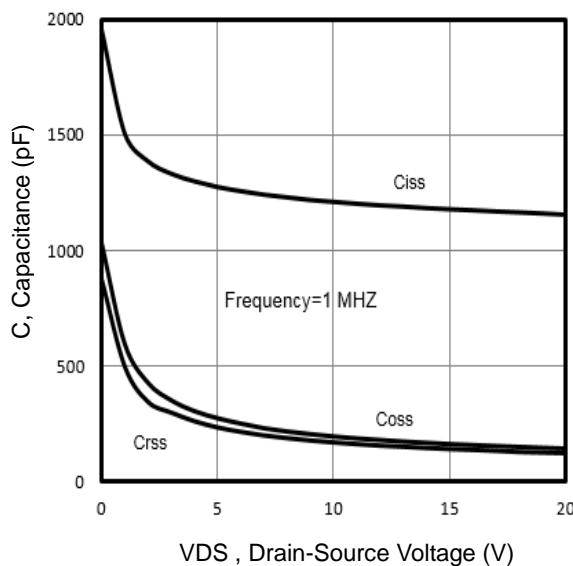


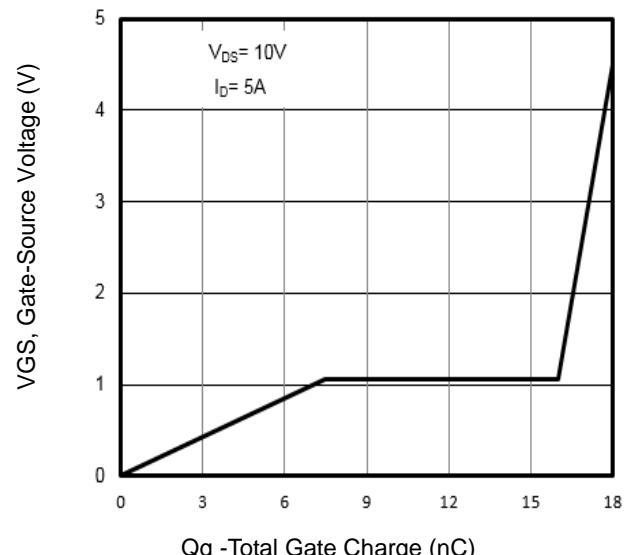
Fig6. Maximum Safe Operating Area



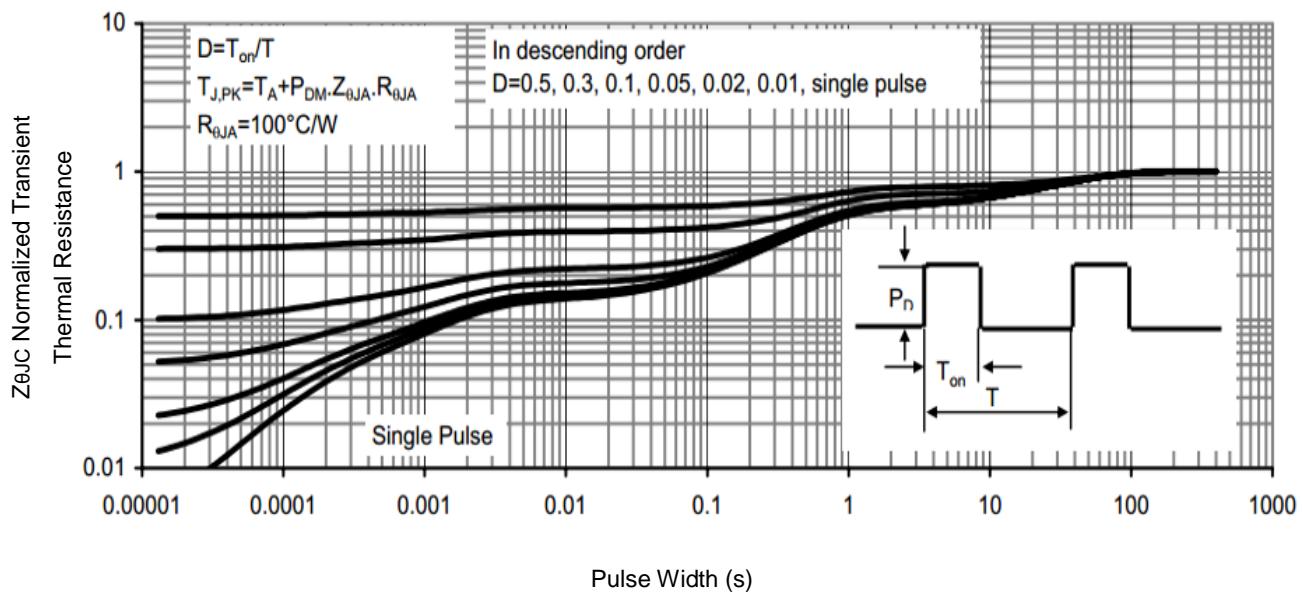
## Typical Characteristics



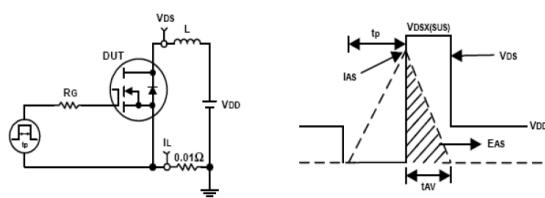
**Fig7.** Typical Capacitance Vs.Drain-Source Voltage



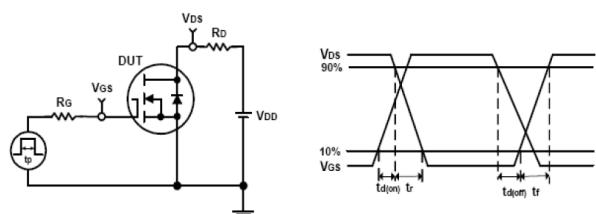
**Fig8.** Typical Gate Charge Vs.Gate-Source Voltage



**Fig9 .** Normalized Maximum Transient Thermal Impedance

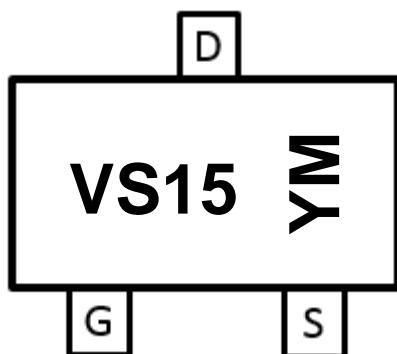


**Fig10.** Unclamped Inductive Test Circuit and waveforms



**Fig11.** Switching Time Test Circuit and waveforms

**Marking Information**

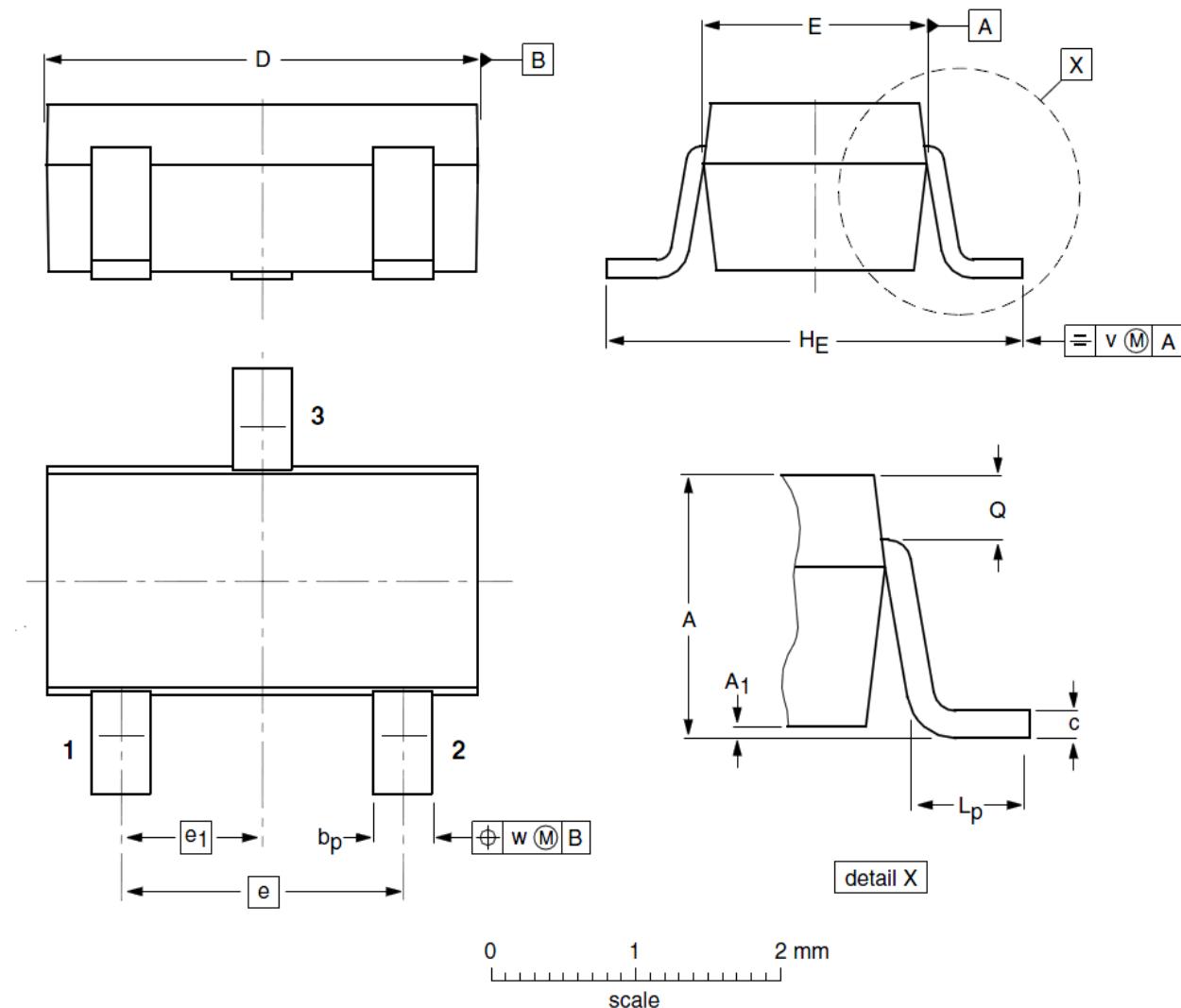


VS15: Part Number

YM: Date Code, Y means assembly year, M means assembly month



### SOT23-3L Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
<b>A</b>	0.90	1.07	1.25
<b>A<sub>1</sub></b>	0.01	0.06	0.10
<b>b<sub>p</sub></b>	0.30	0.35	0.50
<b>c</b>	0.10	0.15	0.20
<b>D</b>	2.70	2.92	3.10
<b>E</b>	1.30	1.60	1.70
<b>e</b>	--	1.90	--
<b>e<sub>1</sub></b>	--	0.95	--
<b>H<sub>E</sub></b>	2.50	2.80	3.00
<b>L<sub>p</sub></b>	0.30	0.40	0.60
<b>Q</b>	0.23	0.29	0.33
<b>v</b>	--	0.20	--
<b>w</b>	--	0.20	--

### Customer Service

**Sales and Service:**

[sales@vgsemi.com](mailto:sales@vgsemi.com)

**Vanguard Semiconductor CO., LTD**

**TEL:** (86-755) -26902410

**FAX:** (86-755) -26907027

**WEB:** [www.vgsemi.com](http://www.vgsemi.com)